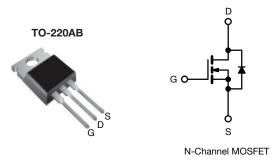
SiHP21N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.205			
Q _g max. (nC)	72				
Q _{gs} (nC)	9				
Q _{gd} (nC)	22				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP21N80AE-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	800	v			
Gate-source voltage			V _{GS}	± 30	v		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	17.4			
	VGS at 10 V	T _C = 100 °C		11	А		
Pulsed drain current ^a			I _{DM}	38			
Linear derating factor				1.4	W/°C		
Single pulse avalanche energy ^b			E _{AS}	127	mJ		
Maximum power dissipation			PD	179	W		
Operating junction and storage temperature range	ge		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope		T _J = 125 °C	70		V/ns		
Reverse diode dv/dt ^d		dv/dt	39	v/ns			
Soldering recommendations (peak temperature)	с	For 10 s		260	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

1



ROHS COMPLIANT

HALOGEN

FREE



THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62			°0.4M			
Maximum junction-to-case (drain)	R _{thJC}	- 0.7				°C/W		
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, 1	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static	-						•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	, I _D = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2.0	-	4.0	V
	I	$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA
Gate-source leakage	I _{GSS}	V _{GS} = ± 30 V			-	-	± 1	μA
Zour anto unline durin comment		V _{DS} =	$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 640 V	, V _{GS} = 0 V	/, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	١	_D = 11 A	-	0.205	0.235	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D	= 3 A	-	4.0	-	S
Dynamic					•			
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1388	-	pF	
Output capacitance	C _{oss}			-	53	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	43	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	276	-		
Total gate charge	Qg				-	48	72	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 11 \text{ A}, \text{ V}_{DS} = 640 \text{ V}$		A, V _{DS} = 640 V	-	9	-	nC
Gate-drain charge	Q _{gd}				-	22	-	
Turn-on delay time	t _{d(on)}				-	21	42	
Rise time	t _r	V _{DD} =	V_{DD} = 640 V, I _D = 11 A, V _{GS} = 10 V, R _g = 20 Ω		-	38	76	ns
Turn-off delay time	t _{d(off)}	V _{GS} =			-	71	107	
Fall time	t _f			-	76	114		
Gate input resistance	Rg	f = 1 MHz, open drain		0.2	0.55	1.1	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	17.4	A	
Pulsed diode forward current	I _{SM}			-	-	38		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 11 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	400	800	ns	
Reverse recovery charge	Q _{rr}			-	5	10	μC	
Reverse recovery current	I _{RRM}			-	20	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

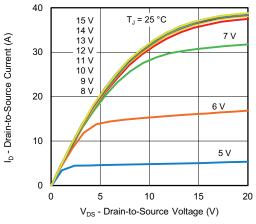


Fig. 1 - Typical Output Characteristics

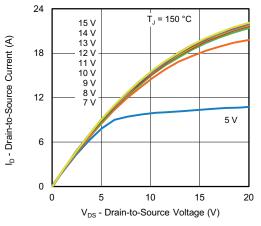


Fig. 2 - Typical Output Characteristics

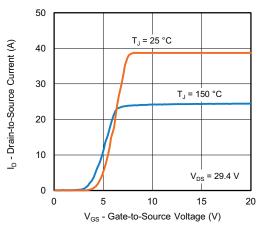


Fig. 3 - Typical Transfer Characteristics

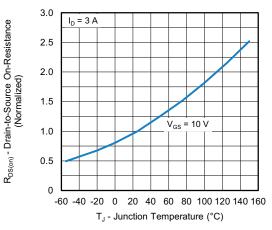


Fig. 4 - Normalized On-Resistance vs. Temperature

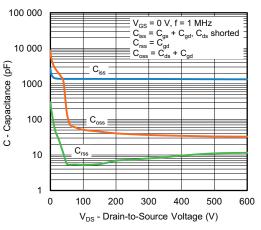
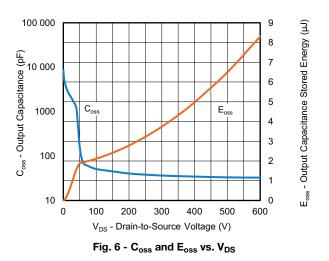


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S20-0729-Rev. C, 21-Sep-2020

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SiHP21N80AE

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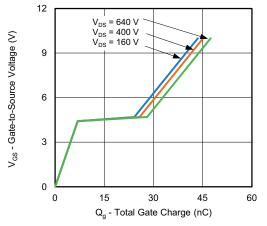


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

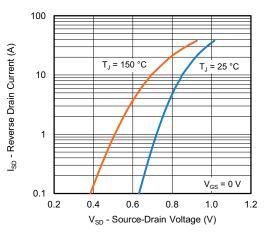


Fig. 8 - Typical Source-Drain Diode Forward Voltage

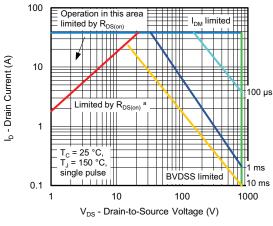


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

4

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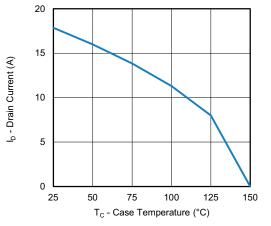


Fig. 10 - Maximum Drain Current vs. Case Temperature

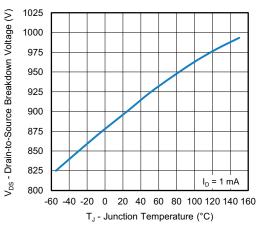


Fig. 11 - Temperature vs. Drain-to-Source Voltage



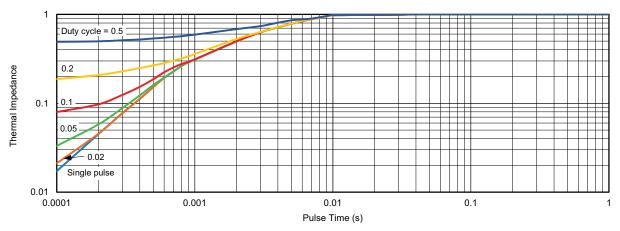


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

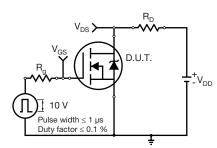


Fig. 13 - Switching Time Test Circuit

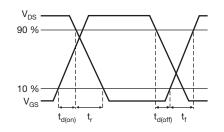


Fig. 14 - Switching Time Waveforms

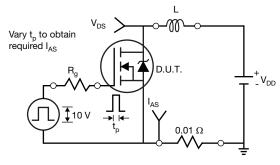


Fig. 15 - Unclamped Inductive Test Circuit

S20-0729-Rev. C, 21-Sep-2020

5

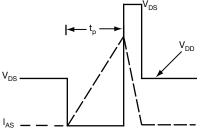


Fig. 16 - Unclamped Inductive Waveforms

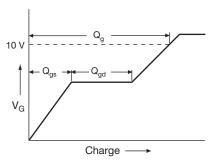
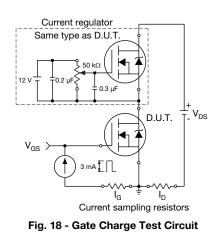
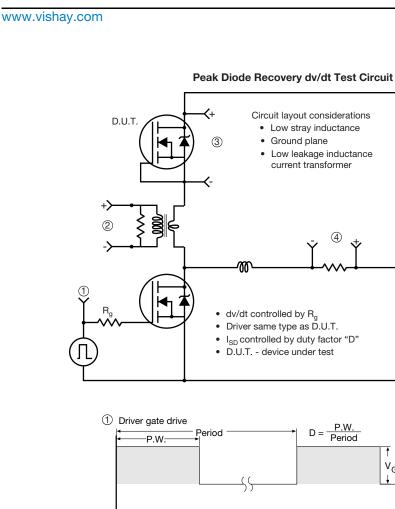


Fig. 17 - Basic Gate Charge Waveform

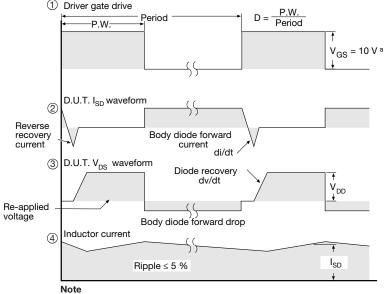


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V_{DD}



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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